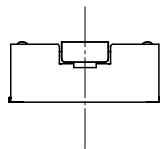
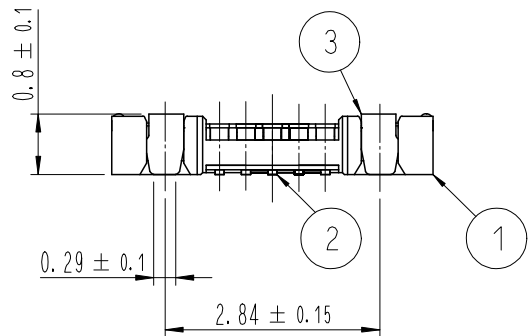
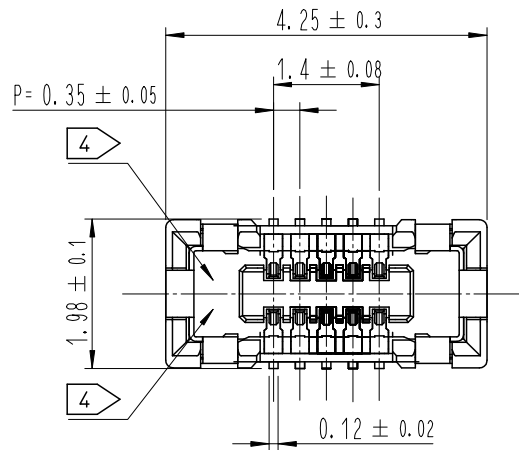


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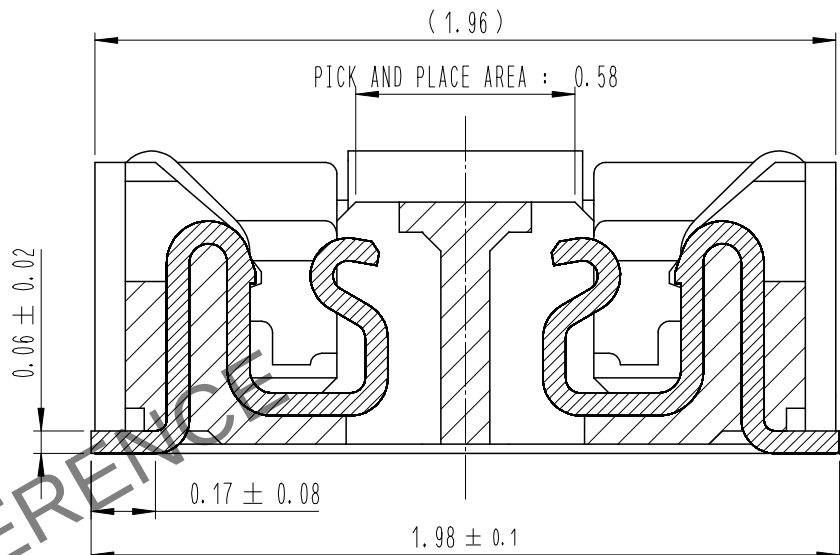


DRAWING FOR REFERENCE
This is subject to change without notice

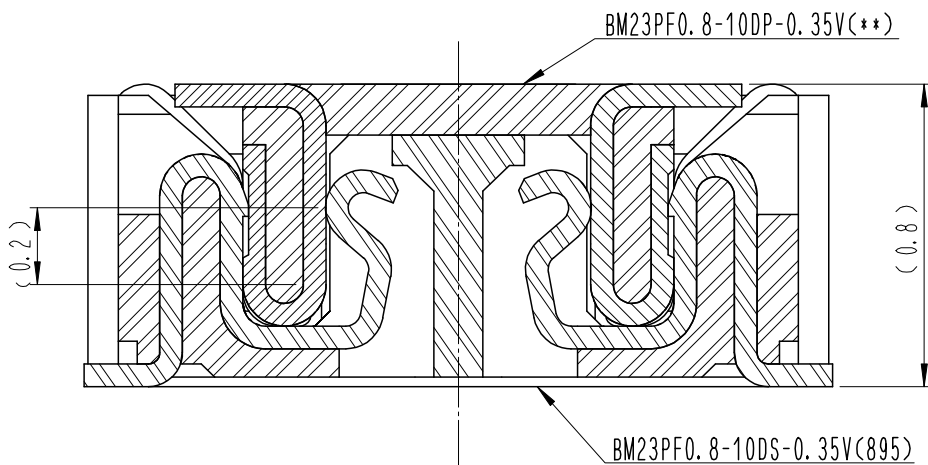
- NOTE
- 1 . ALL LEAD CO-PLANARITY SHALL BE 0.08mm MAX.
 - 2 CONTACT PLATING SPECIFICATIONS.
CONTACT AREA : GOLD 0.05 μ m MIN.
SMT LEAD : GOLD 0.05 μ m MIN.
UNDERPLATING : NICKEL 1 μ m MIN.
(SURFACE : SEALING)
 - 3 MATA FITTING PLATING SPECIFICATIONS.
SMT LEAD : GOLD 0.05 μ m MIN.
UNDERPLATING : NICKEL 1 μ m MIN.
(SURFACE : SEALING)
 - 4 HRS MARK AND CAV NO. IS INDICATED IN APPROX POSITION SHOWN.

	△數	訂正事項	擔當	檢圖	年月日		△數	訂正事項	擔當	檢圖	年月日		
	COUNT	DESCRIPTION OF REVISIONS	B	Y	CHKD	DATE		COUNT	DESCRIPTION OF REVISIONS	B	Y	CHKD	DATE
△						. .	△						. .
△						. .	△						. .
△						. .	△						. .

A-A(50:1)

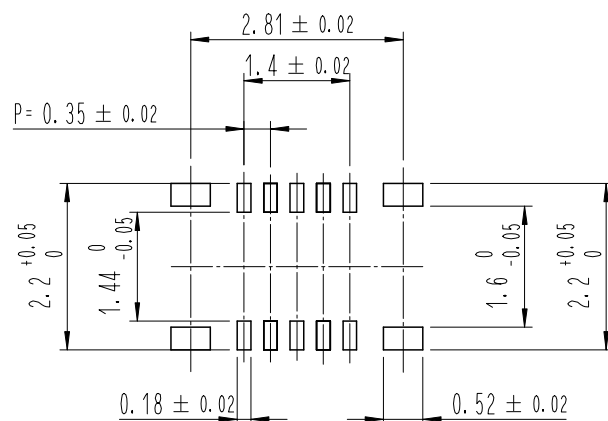


ENGAGEMENT FIGURE (50:1)

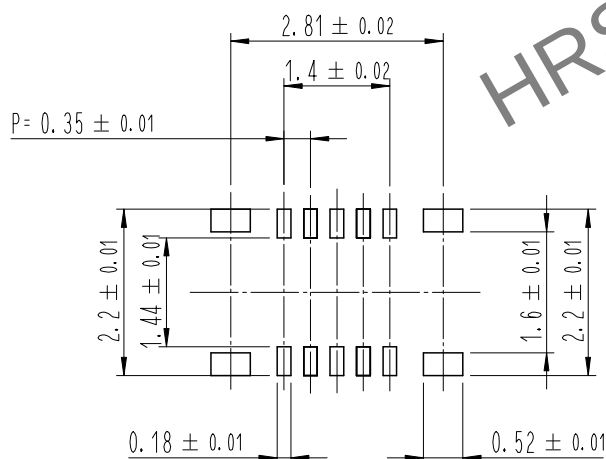


4	PS	CLEAR (EMBOSSED CARRIER TAPE)			
3	COPPER ALLOY	3			
2	COPPER ALLOY	2	6	PS	BLACK (PLASTIC REEL)
1	LCP	UL94 V-0, BLACK	5	POLYESTER	CLEAR (COVER TAPE)
NO.	MATERIAL	FINISH , REMARKS	NO.	MATERIAL	FINISH , REMARKS
REMARKS			DRAWN	DESIGNED	CHECKED
			S. H. JUNG	S. H. JUNG	H. W. JO
			17. 05. 09	17. 05. 09	17. 05. 09
				APPROVED	RELEASED
				T. S. KANG	17. 05. 09
CODE NO. (OLD)	SCALE	DRAWING NO.	PART NO.		
	10:1	EDC3-631938	BM23PF0.8-10DS-0.35V(895)		
	UNITS	HIROSE KOREA CO., LTD.	CODE NO		
	mm		CL 6644-0033-3-895		
					1/3

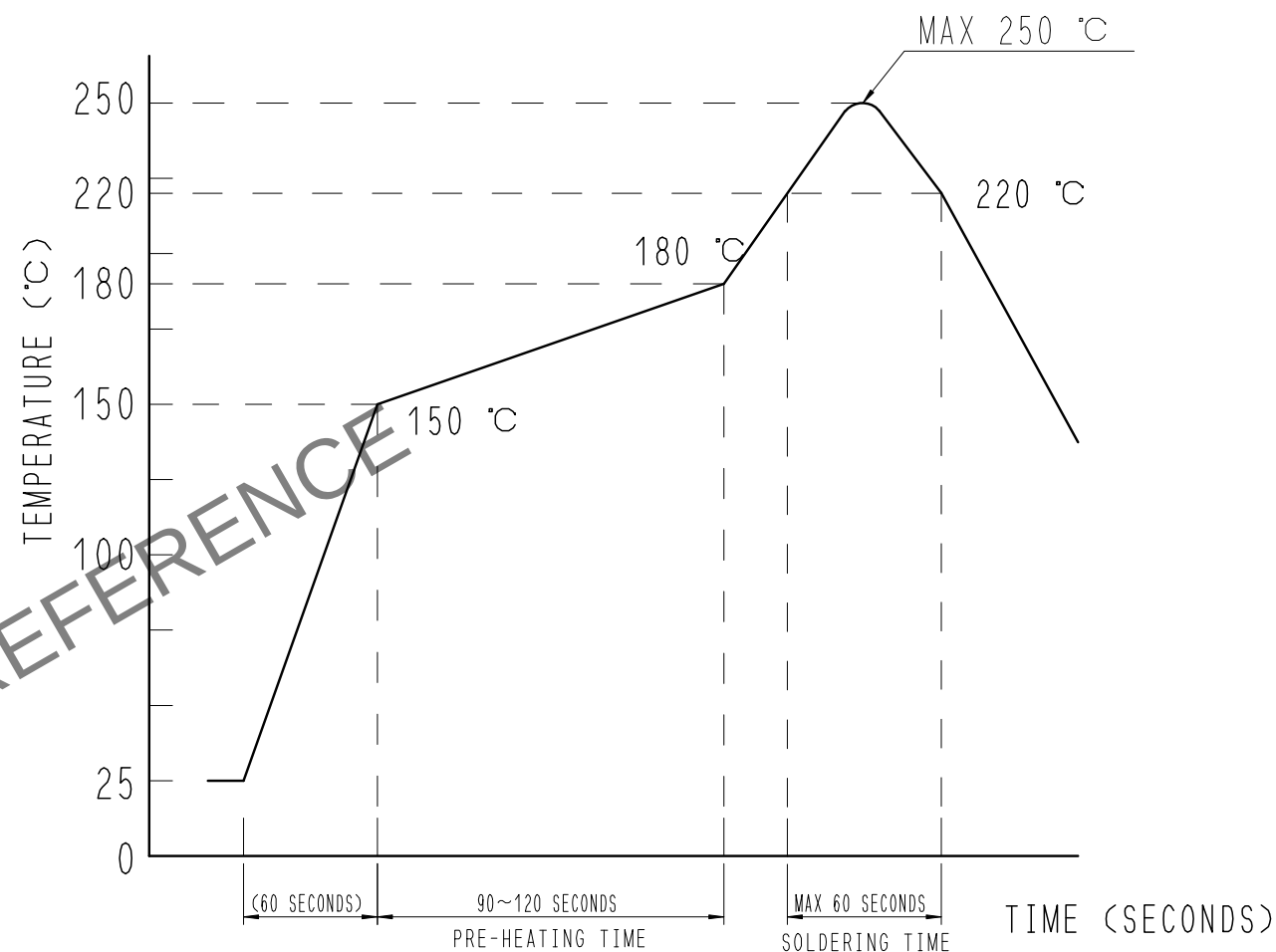
6 RECOMMENDED PCB LAYOUT



RECOMMENDED METAL MASK DIMENSIONS
MATAL MASK THICKNESS : 100 μm



5 RECOMMENDED REFLOW TEMPERATURE PROFILE
USING LEAD-FREE SOLDER PASTE.



REFLOW METHOD: N2 REFLOW
NUMBER OF REFLOW CYCLES: 2 CYCLES MAX.
1) REFLOW TIME
DURATION ABOVE 220°C: 60 SEC MAX.
(PEAK TEMPERATURE: 250°C MAX)
2) PRE-HEAT TIME
PRE-HEAT TEMPERATURE (MIN): 150°C
PRE-HEAT TEMPERATURE (MAX): 180°C
PRE-HEAT TIME: 90~120 SEC.

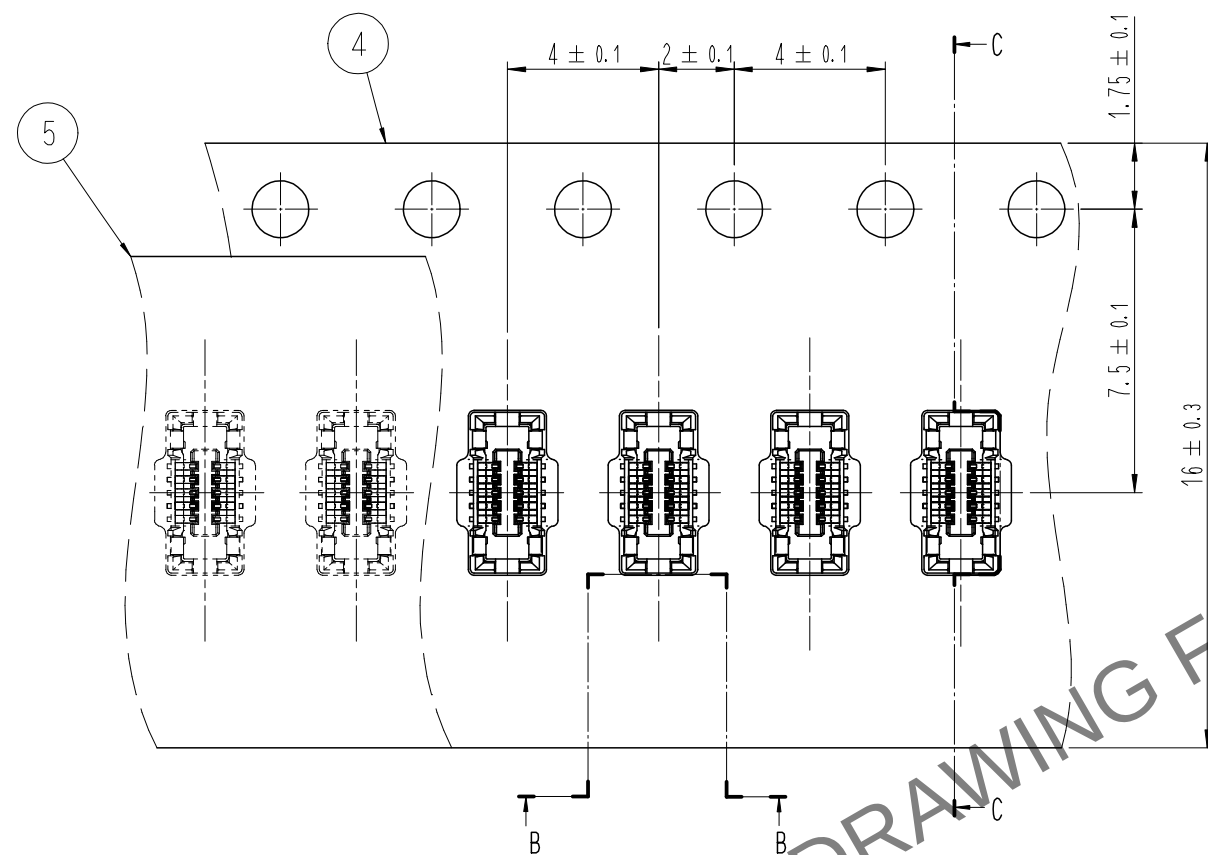
- 5 THIS TEMPERATURE PROFILE IS PER THE CONDITIONS SHOWN ABOVE. ADDITIONAL FACTORS, SUCH AS SOLDER PASTE TYPE, PCB SIZE AND OTHER MOUNTED COMPONENTS COULD AFFECT THE PROFILE. THEREFORE, A THOROUGH EVALUATION OF MOUNTING CONDITION IS REQUIRED PRIOR TO PRODUCTION. TEMPERATURE IS MEASURED AT CONTACT LEAD.
- 6 PLEASE CONTACT US IN CASE YOU WILL MAKE DIFFERENT SETTINGS FROM OUR RECOMMENDATION.

	DRAWING NO.	EDC3-631938	PART NO.	BM23PF0.8-10DS-0.35V(895)
	SCALE	10:1	CODE NO.	CL 6644-0033-3-895
	UNITS	mm		

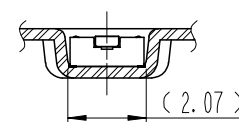
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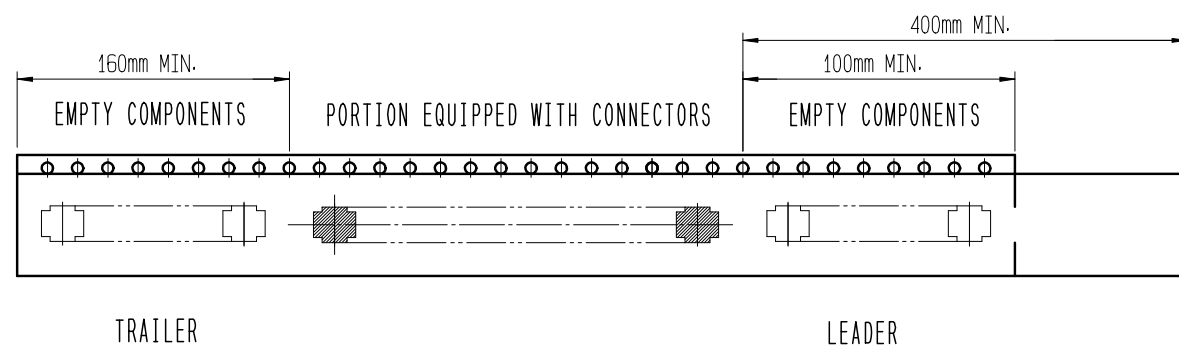
EMBOSSED CARRIER TAPE PACKAGING (5:1)



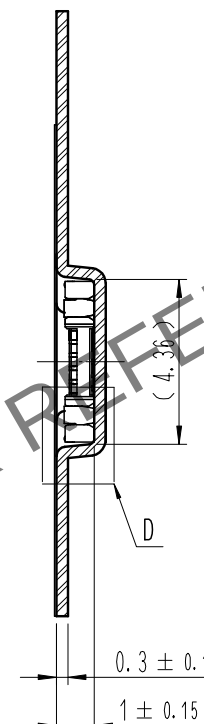
B-B (5:1)



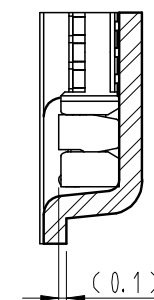
10 TAPING(FREE)



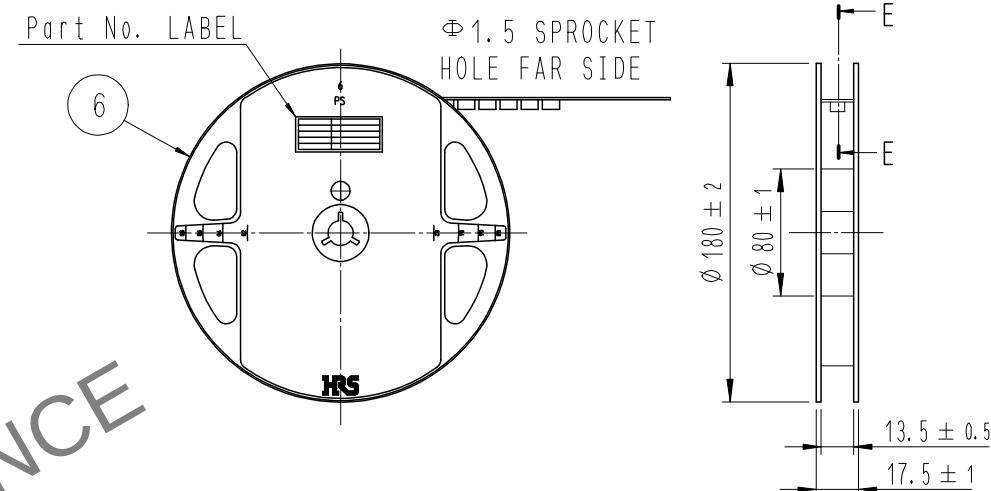
C-C (5:1)



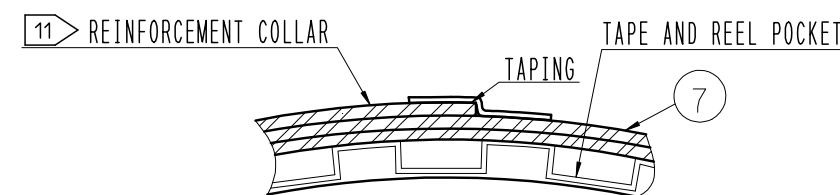
D (10:1)



STYLE AND DIMENTION OF REEL (FREE)



E-E (FREE)



DETAIL OF PART No. LABEL

SUPPLIER	
QUANTITY	
PART NO.	
CODE NO.	
DATE OF MANUFACTURED	
生産月日	年 月 日
図番	** ** *
品名	BM23PF0.8-10DS-0.35V(895)
納入数量	1,000個
納入者	HIROSE KOREA

7 . PER REEL 1,000 CONNECTORS.

8 . THE DIMENSIONS IN PARENTHESES ARE FOR REFERENCE.

9 REFER TO JIS C 0806, IEC-60286-3 (PACKAGING OF COMPONENTS FOR AUTOMATIC HANDLING)

10 AFTER PACKAGING, ROLL 2 METERS OF THE REINFORCEMENT COLLAR TO OUTER CIRCUMFERENCE OF TAPE AND REEL POCKET, AND TAPE DOWN AT THE END THE COLLAR.

DRAWING NO.	EDC3-631938	PART NO.	BM23PF0.8-10DS-0.35V(895)
SCALE	10:1	CODE NO	CL 6644-0033-3-895
UNITS	mm		
	HRS HIROSE KOREA CO., LTD.		